

RS1A/B - RS1M/B

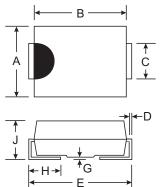
1.0A SURFACE MOUNT FAST RECOVERY RECTIFIER

Features

- Glass Passivated Die Construction
- Fast Recovery Time For High Efficiency
- Low Forward Voltage Drop and High Current Capability
- Surge Overload Rating to 30A Peak
- Ideally Suited for Automated Assembly
- Available in Lead Free Finish/RoHS Compliant Version (Note 4)

Mechanical Data

- Case: SMA/SMB
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Solder Plated Terminal Solderable per MIL-STD-202, Method 208
- Also Available in Lead Free Plating (Matte Tin Finish). Please see Ordering Information, Note 6, on Page 1
- Polarity: Cathode Band or Cathode Notch
- SMA Weight: 0.064 grams (approximate)
- SMB Weight: 0.093 grams (approximate)



Dim	SI	ΛA	SMB			
	Min	Мах	Min	Мах		
Α	2.29	2.92	3.30	3.94		
В	4.00	4.60	4.06	4.57		
С	1.27	1.63	1.96	2.21		
D	0.15	0.31	0.15	0.31		
Е	4.80	5.59	5.00	5.59		
G	0.10	0.20	0.10	0.20		
Н	0.76	1.52	0.76	1.52		
J	2.01	2.30	2.00	2.40		

A, B, D, G, J, K, M Suffix Designates SMA Package AB, BB, DB, GB, JB, KB, MB Suffix Designates SMB Package

Maximum Ratings and Electrical Characteristics @ T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristic		Symbol	RS1 A/AB	RS1 B/BB	RS1 D/DB	RS1 G/GB	RS1 J/JB	RS1 K/KB	RS1 M/MB	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} VR	50	100	200	400	600	800	1000	V
RMS Reverse Voltage		V _{R(RMS)}	35	70	140	280	420	560	700	V
Average Rectified Output Current @ $T_T = 120^{\circ}C$		lo	1.0						Α	
Non-Repetitive Peak Forward Surge Current, 8.3ms single half sine-wave Superimposed on Rated Load (JEDEC Method)		I _{FSM}	30						А	
Forward Voltage Drop	@ I _F = 1.0A	VFM	1.3				V			
	$T_{A} = 25^{\circ}C$ $T_{A} = 125^{\circ}C$	I _{RM}	5.0 200				μA			
Reverse Recovery Time (Note 3)		t _{rr}		15	50		250	50	00	ns
Typical Total Capacitance (Note 2)		Ст	15					pF		
Typical Thermal Resistance, Junction to Terminal (Note 1)		R _{θJT}	20						°C/W	
Operating and Storage Temperature Range		T _{j,} T _{STG}	-65 to +150					°C		

Notes: 1. Valid provided that terminals are kept at ambient temperature.

- 2. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.
- 3. Reverse Recovery Test Conditions: I_F = 0.5A, I_R = 1.0A, I_{rr} = 0.25A. See figure 5.

4. RoHS revision 13.2.2003. Glass and High Temperature Solder Exemptions Applied, see EU Directive Annex Notes 5 and 7.

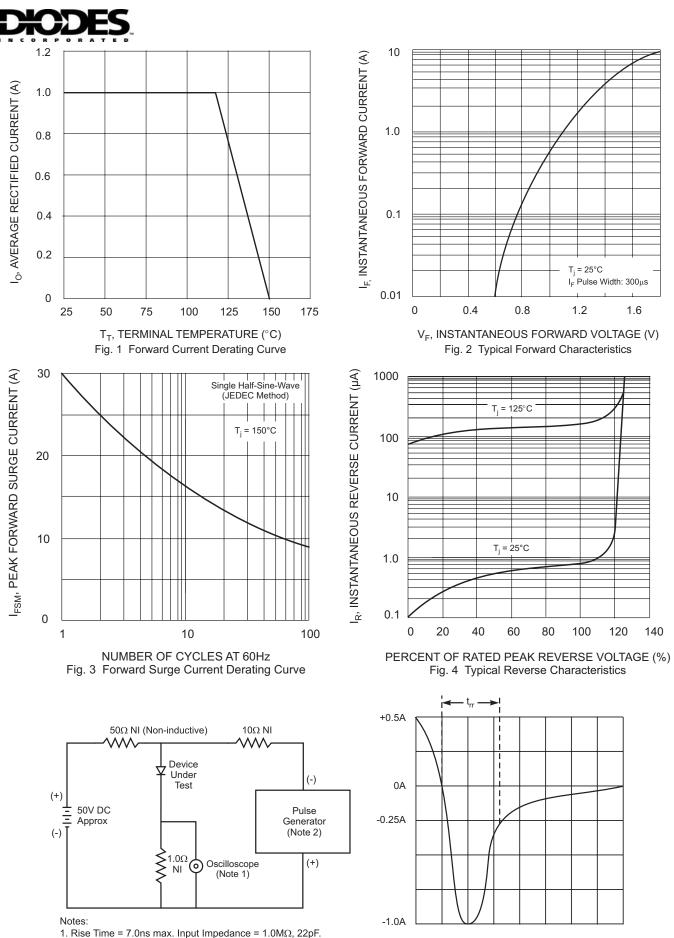
Ordering Information (Note 5 & 6)

Device*	Packaging	Shipping
RS1x-13	SMA	5000/Tape & Reel
RS1xB-13	SMB	3000/Tape & Reel

* x = Device type, e.g. RS1D-13 (SMA package); RS1JB-13 (SMB package).

Notes: 5. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

6. For Lead Free Finish/RoHS Compliant version part numbers, please add "-F" suffix to the part numbers above. Example: RS1B-13-F.



2. Rise Time = 10ns max. Input Impedance = 10002, 1

Fig. 5 Reverse Recovery Time Characteristic and Test Circuit

Set time base for 50/100 ns/cm